

Amendments to the Specification

Please amend the specification as follows:

On page 4, lines 9-15:

In one embodiment, each of the diode compartments includes a diode surrounded by heat conductive, electrically non-conductive epoxy contacting substantially all surfaces of the heat sink within the apertures.

In another embodiment, each of the diode compartments includes a diode formed from a rectifier die electrically connected to first and second copper tabs wherein the first copper tab is directly electrically connected to a contact surface in the aperture and the second copper tab is electrically connected to the rectifier bridge circuit.

On page 5, line 18:

Figure 10 is structural view of the ~~positive-based~~ diode of Figure 9;